# imall

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## FFPF20UP20DP Ultrafast Recovery Power Rectifier

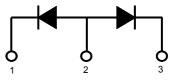
### Features

- Ultrafast with Soft Recovery : < 45ns (@I<sub>F</sub> = 10A)
- High Reverse Voltage : V<sub>RRM</sub> = 200V
- Enhanced Avalanche Energy Rated
- Planar Construction

### Applications

- Output Rectifiers
- Switching Mode Power Supply
- Free-wheeling Diode
- Power Switching Circuits





1. Cathode 2. Anode 3. Cathode

1.Anode 2.Cathode 3.Anode

Absolute Maximum Ratings (per diode)  $T_{C} = 25^{\circ}C$  unless otherwise noted

Symbol	Parameter	Value	Units	
V <sub>RRM</sub>	Peak Repetitive Reverse Voltage	200	V	
V <sub>RWM</sub>	Working Peak Reverse Voltage	200	V	
V <sub>R</sub>	DC Blocking Voltage	200	V	
I <sub>F(AV)</sub>	Average Rectified Forward Current @ T <sub>C</sub> = 115°C	10	A	
I <sub>FSM</sub>	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	100	A	
$T_{J,}T_{STG}$	Operating Junction and Storage Temperature	- 65 to +150	°C	

### **Thermal Characteristics**

Symbol	Parameter	Мах	Units
$R_{ ext{ heta}JC}$	Maximum Thermal Resistance, Junction to Case	4.3	°C/W

### Package Marking and Ordering Information

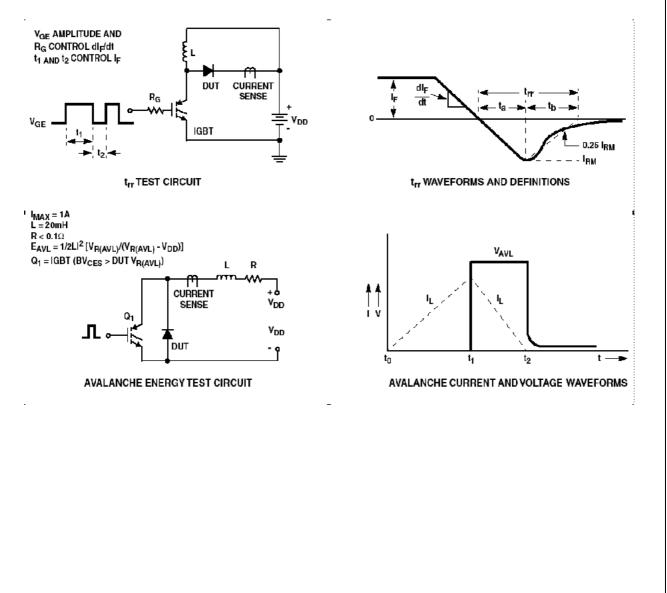
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
F20UP20DP	FFPF20UP20DPTU	TO-220F	-	-	50

Symbol	Parameter		Min.	Тур.	Max.	Units
V <sub>FM</sub> *	I <sub>F</sub> = 10A I <sub>F</sub> = 10A	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	-	-	1.15 1.0	V V
I <sub>RM</sub> *	V <sub>R</sub> = 200V V <sub>R</sub> = 200V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	-	-	100 500	μΑ μΑ
t <sub>rr</sub>	$I_F$ =1A, di/dt = 100A/µs, V <sub>CC</sub> = 30V $I_F$ =10A, di/dt = 200A/µs, V <sub>CC</sub> = 130V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 25 °C	-	-	35 45	ns ns
t <sub>a</sub> t <sub>b</sub> Q <sub>rr</sub>	I <sub>F</sub> =10A, di/dt = 200A/μs, V <sub>CC</sub> = 130V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 25 °C T <sub>C</sub> = 25 °C T <sub>C</sub> = 25 °C	- -	15 12 36	- - -	ns ns nC
W <sub>AVL</sub>	Avalanche Energy (L = 20mH)	•	10	-	-	mJ

### Electrical Characteristics (per diode) T<sub>C</sub> = 25°C unless otherwise noted

\* Pulse Test: Pulse Width=300 $\mu s,$  Duty Cycle=2%

### **Test Circuit and Waveforms**



FFPF20UP20DP Ultrafast Recovery Power Rectifier

# <figure>

**Typical Performance Characteristics** 



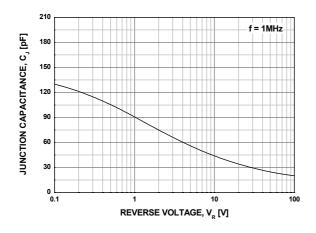


Figure 5. Typical Reverse Recovery Current

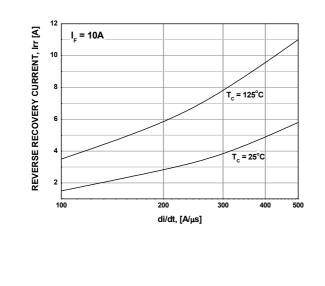


Figure 2. Typical Reverse Current

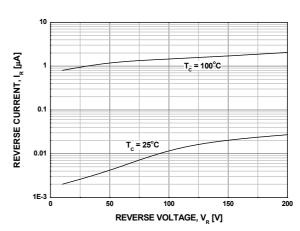


Figure 4. Typical Reverse Recovery Time

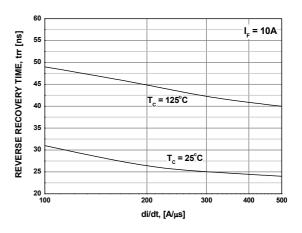
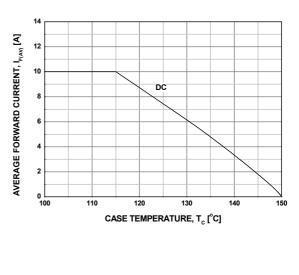
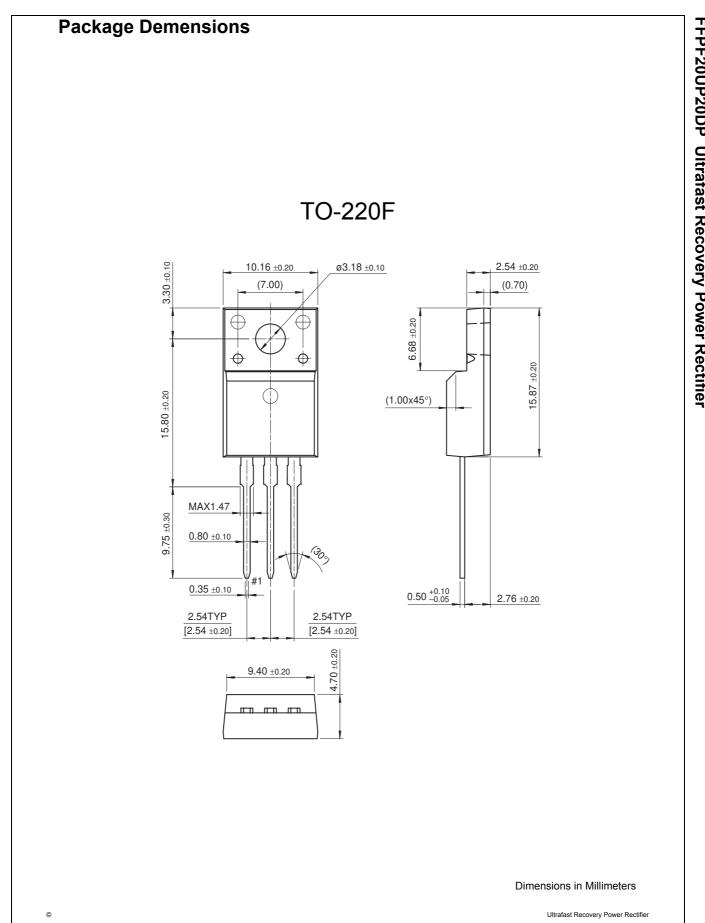


Figure 6. Forward Current Deration Curve





FFPF20UP20DP Ultrafast Recovery Power Rectifier

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Rev. 118